

Product data sheet

1. General description

Planar passivated four quadrant triac in a SOT1292 (IITO3P) package intended for use in circuits where high static and dynamic dV/dt and high dI/dt can occur. This triac will commutate the full RMS current at the maximum rated junction temperature ($T_{j(max)} = 150$ °C). It is used in applications where "high junction operating temperature capability" is required.

2. Features and benefits

- High current TRIAC
- Low thermal resistance
- High junction operating temperature capability (T_{i(max)} = 150 °C)
- High voltage capability
- Planar passivated for voltage ruggedness and reliability
- Insulated tab rated at 2500 V rms

3. Applications

- High current / high surge applications
- High power / industrial controls -- e.g. heating, motors, lighting

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit
Absolute	maximum rating			
V_{DRM}	repetitive peak off-state voltage		800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 92 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	45	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	450	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C;	495	А
Tj	junction temperature		150	°C

BTA45-800B

4Q Triac

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	·				
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T2+ G+ T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	-	-	50	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} T_{j} = 25 \text{ °C}; Fig. 7$	-	-	50	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+ T _j = 25 °C; <u>Fig. 7</u>	-	-	70	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	80	mA
V _T	on-state voltage	I _T = 63.6 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.7	V
Dynamic	characteristics					
dV _D /dt rate of rise of off-stat voltage		V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	750	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	20	-	-	A/ms
		V_D = 400 V; T _j = 150 °C; I _{T(RMS)} = 20A; dV _{com} /dt = 20 V/µs; gate open circuit	10	-	-	A/ms

5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	T1	main terminal 1	\bigcirc	T2T1			
2	T2	main terminal 2		Sym051			
3	G	gate		Symoor			
mb	n.c.	mounting base; isolated	IITO3P (SOT1292)				

6. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BTA45-800B	IITO3P	plastic single-ended through-hole package; isolated heatsink mounted; 1 mounting hole; 3-lead TO3P	SOT1292	

7. Marking

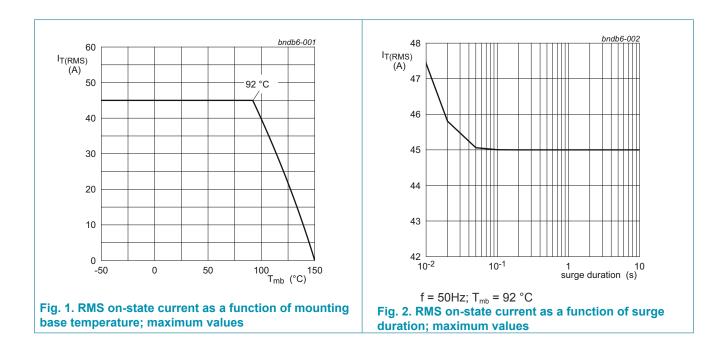
Table 4. Marking codes			
Type number		Marking codes	
BTA45-800B		BTA45-800B	
BTA45-800B	All information provided in this docume	nt is subject to legal disclaimers.	© WeEn Semiconductors Co., Ltd. 2017. All rights reserved
Product data sheet	10 July 201	7	2 / 12

8. Limiting values

Table 4. Limiting values

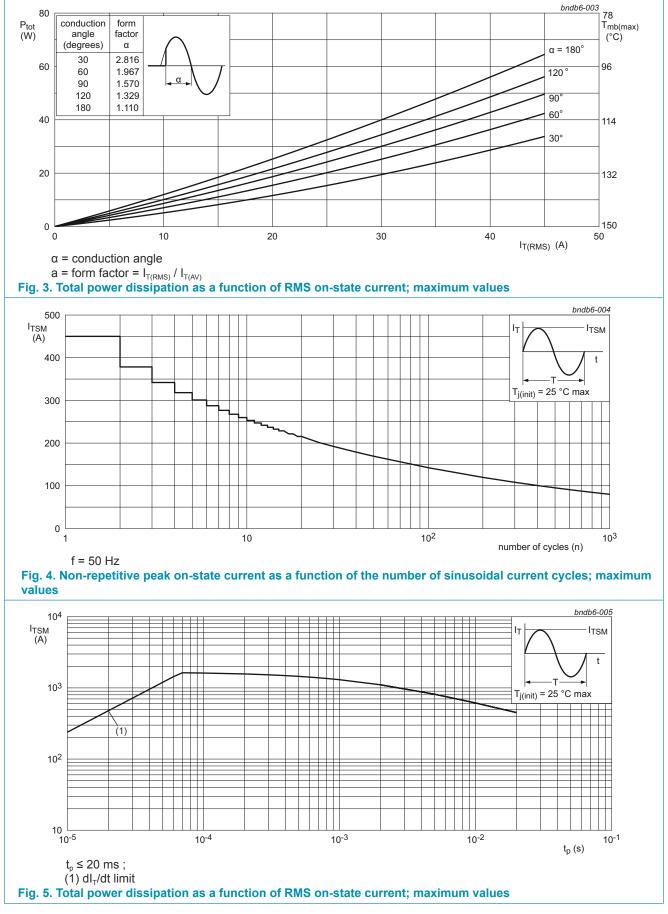
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{DRM}	repetitive peak off-state voltage		800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 92°C; <u>Fig. 1</u> ; <u>Fig. 2; Fig. 3</u>	45	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	450	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C;	495	A
l ² t	l ² t for fusing	t _p = 10ms; sine wave	1012.5	A²s
dl _⊤ /dt	rate of rise of on-state current	I _G = 150mA	150	A/µs
I _{GM}	peak gate current	t _p = 20µs	8	А
P _{GM}	peak gate power	t _p = 20µs	40	W
$P_{G(AV)}$	average gate power	over any 20 ms period	1	W
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C



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Unit

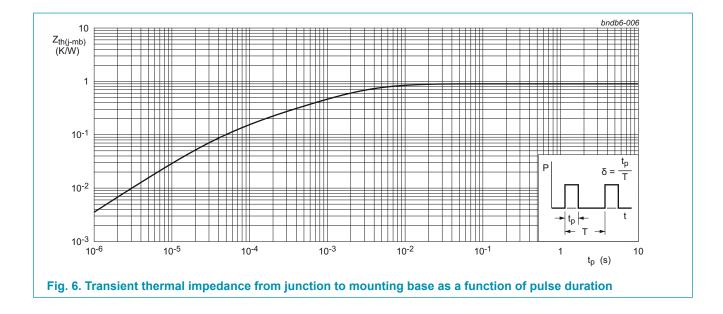
K/W

K/W

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Table 5. Th	Table 5. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Max			
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>		-	-	0.9			
$R_{th(j-a)}$	thermal resistance from junction to	in free air		-	55	-			

9. Thermal characteristics

ambient free air



10. Isolation characteristics

Table 6. IsSymbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	from all terminal to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C	-	-	2500	V

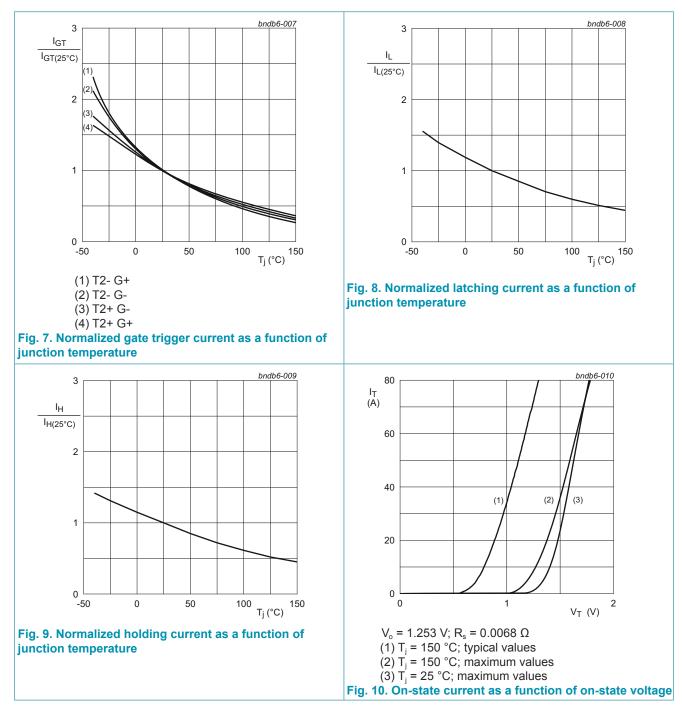
11. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	racteristics					
I _{GT} gate trigger c	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}2+\text{ G}+;$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 7}$	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; Fig. 7	-	-	50	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>	-	-	50	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u>	-	-	70	mA
l	latching current	V_{D} = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; Fig. 8	-	-	100	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	160	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-	100	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 8</u>	-	-	100	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	80	mA
V _T	on-state voltage	I _T = 63.6 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.7	V
V _{GT} g	gate trigger voltage	$V_{\rm D}$ = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	0.8	1.3	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C; <u>Fig. 11</u>	0.2	0.45	-	V
l _D	off-state current	V _D = 800 V; T _j = 25 °C	-	-	10	μA
		V _D = 800 V; T _j = 150 °C	-	-	2.5	mA
Dynamic o	characteristics					·
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	750	-	-	V/µs
		V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$ V_{\rm D} = 400 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{I}_{\text{T(RMS)}} = 20\text{A}; \\ $	20	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 150 \text{ °C}; \text{ I}_{T(RMS)} = 20\text{ A};$ $dV_{com}/dt = 20 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	10	-	-	A/ms

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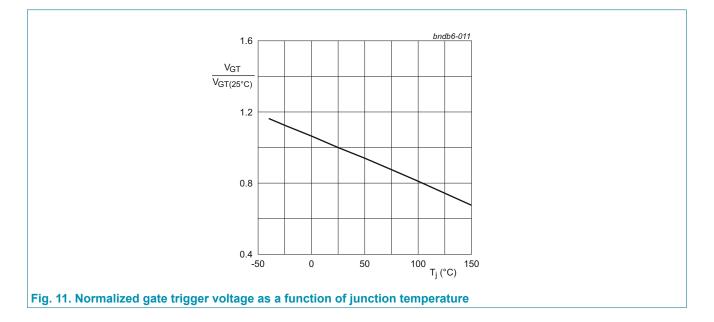
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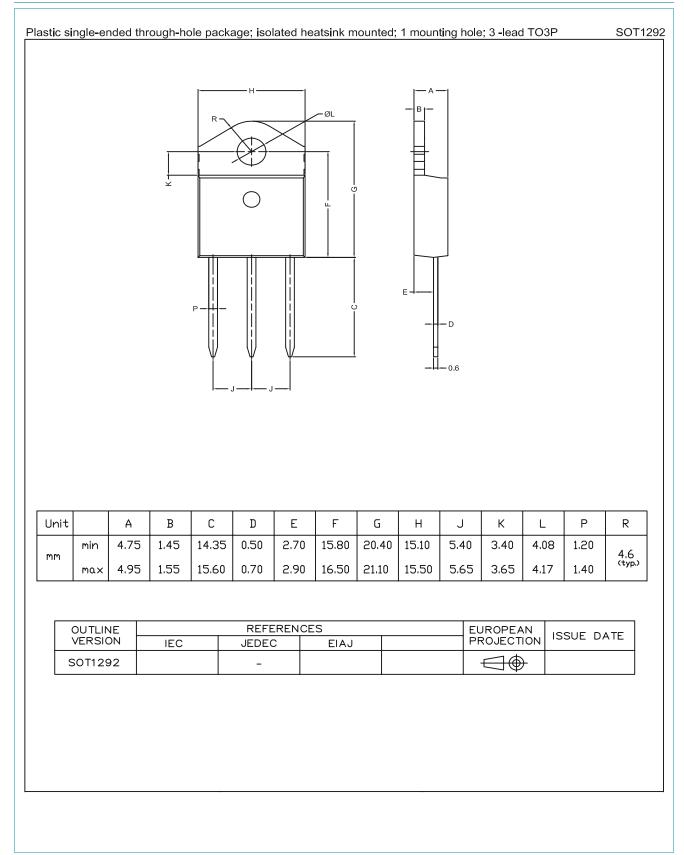


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BTA45-800B **4Q Triac**



12. Package outline



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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14. Contents

1. General description	1
2. Features and benefits	1
3. Applications	1
4. Quick reference data	1
5. Pinning information	2
6. Ordering information	2
7. Marking	2
8. Limiting values	3
9. Thermal characteristics	5
10. Isolation characteristics	5
11. Characteristics	6
12. Package outline	9
13. Legal information	10
14. Contents	12

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